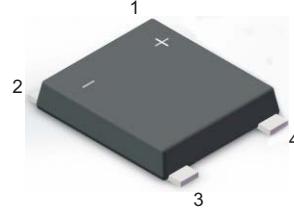
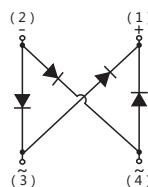




### Features:

- Glass Passivated Chip Junction
- Reverse Voltage - 100 to 1000 V
- Forward Current - 2.0 A
- High Surge Current Capability
- Designed for Surface Mount Application

UMSB

### PINNING

PIN	DESCRIPTION
1	Output Anode ( + )
2	Output Cathode ( - )
3	Input Pin ( ~ )
4	Input Pin ( ~ )

### Absolute Maximum Ratings (Ta=25°C unless otherwise noted)

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

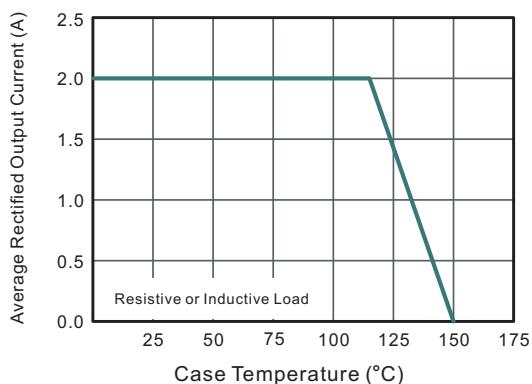
Parameter	Symbols	MSB20B	MSB20D	MSB20G	MSB20J	MSB20K	MSB20M	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	100	200	400	600	800	1000	V
Average Rectified Output Current	I <sub>O</sub>					2.0		A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>					50		A
Maximum Forward Voltage at 2.0 A	V <sub>F</sub>				1.1			V
Maximum DC Reverse Current @T <sub>A</sub> =25 °C at Rated DC Blocking Voltage @T <sub>A</sub> =125 °C	I <sub>R</sub>			5	100			µA
Typical Junction Capacitance ( Note1 )	C <sub>j</sub>			30				pF
Typical Thermal Resistance ( Note2 )	R <sub>θJA</sub> R <sub>θJC</sub> R <sub>θJL</sub>			60 10 25				°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>			-55 ~ +150				°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

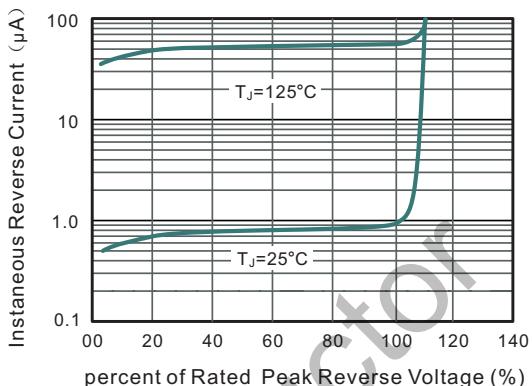
2. Mounted on glass epoxy PC board with 4×1.5"×1.5" ( 3.81×3.81 cm ) copper pad.

## Typical Characteristics

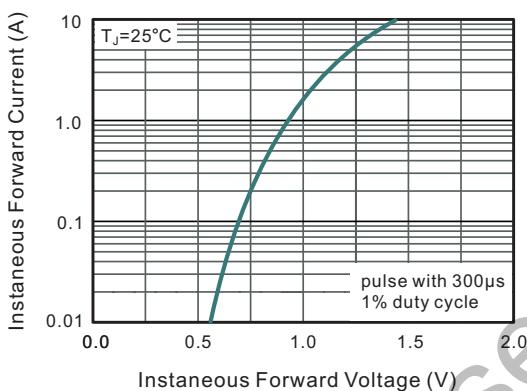
**Fig.1 Average Rectified Output Current Derating Curve**



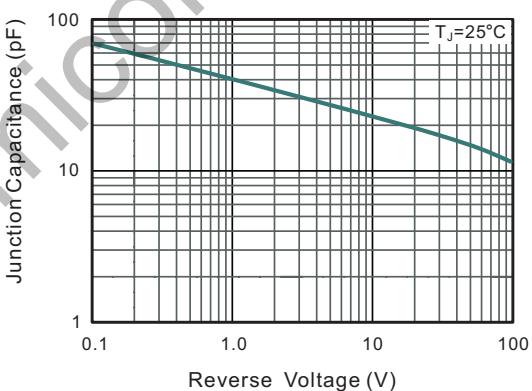
**Fig.2 Typical Reverse Characteristics**



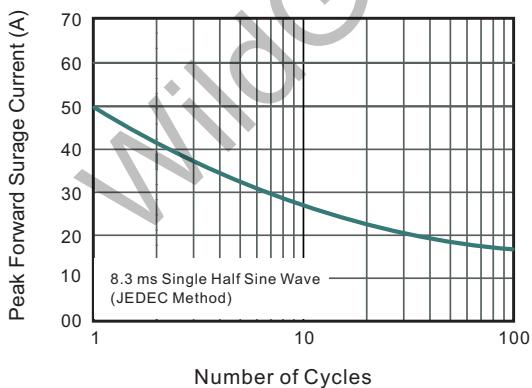
**Fig.3 Typical Instantaneous Forward Characteristics**



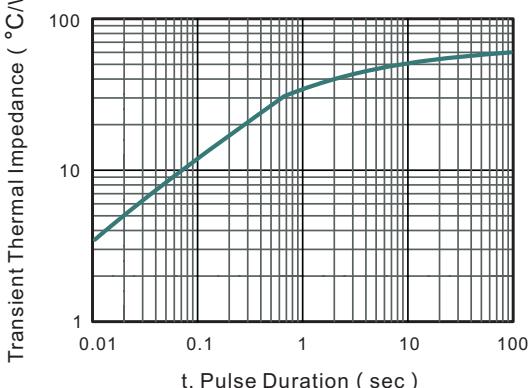
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**

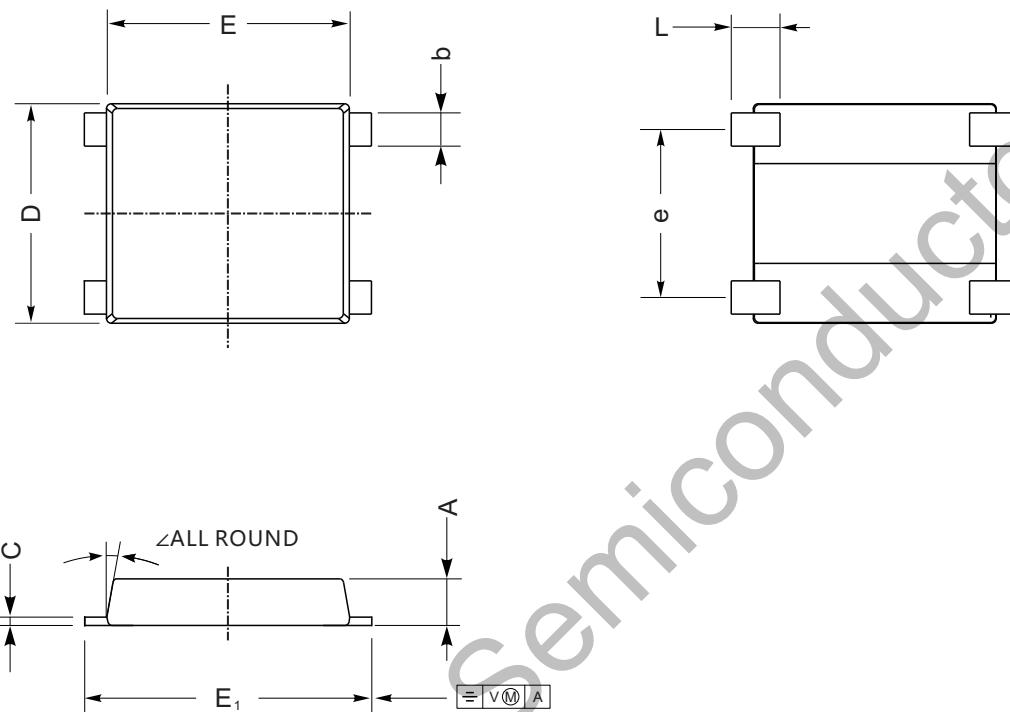


**Fig.6- Typical Transient Thermal Impedance**



Package Dimension

UMSB



UMSB mechanical data

UNIT		A	C	D	E	E <sub>1</sub>	L	e	b	$\angle$
mm	max	1.5	0.29	7.0	7.6	8.9	1.6	5.3	1.15	10°
	min	1.3	0.17	6.2	7.1	8.4	1.0	4.9	0.95	
mil	max	59	12	276	299	350	55	209	45	10°
	min	51	7	244	280	331	31.5	193	37	

## Marking

Type number	Marking code
MSB20B	MB20B
MSB20D	MB20D
MSB20G	MB20G
MSB20J	MB20J
MSB20K	MB20K
MSB20M	MB20M